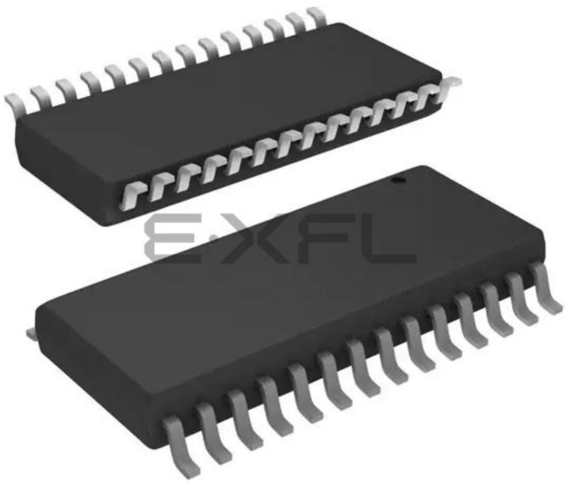

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	64KB (32K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	3.8K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 19x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f26k22t-i-so

1.2 Other Special Features

- **Memory Endurance:** The Flash cells for both program memory and data EEPROM are rated to last for many thousands of erase/write cycles – up to 10K for program memory and 100K for EEPROM. Data retention without refresh is conservatively estimated to be greater than 40 years.
- **Self-programmability:** These devices can write to their own program memory spaces under internal software control. By using a bootloader routine located in the protected Boot Block at the top of program memory, it becomes possible to create an application that can update itself in the field.
- **Extended Instruction Set:** The PIC18(L)F2X/4XK22 family introduces an optional extension to the PIC18 instruction set, which adds eight new instructions and an Indexed Addressing mode. This extension, enabled as a device configuration option, has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as C.
- **Enhanced CCP module:** In PWM mode, this module provides one, two or four modulated outputs for controlling half-bridge and full-bridge drivers. Other features include:
  - Auto-Shutdown, for disabling PWM outputs on interrupt or other select conditions
  - Auto-Restart, to reactivate outputs once the condition has cleared
  - Output steering to selectively enable one or more of four outputs to provide the PWM signal.
- **Enhanced Addressable EUSART:** This serial communication module is capable of standard RS-232 operation and provides support for the LIN bus protocol. Other enhancements include automatic baud rate detection and a 16-bit Baud Rate Generator for improved resolution. When the microcontroller is using the internal oscillator block, the EUSART provides stable operation for applications that talk to the outside world without using an external crystal (or its accompanying power requirement).
- **10-bit A/D Converter:** This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reduce code overhead.
- **Extended Watchdog Timer (WDT):** This enhanced version incorporates a 16-bit postscaler, allowing an extended time-out range that is stable across operating voltage and temperature. See **Section 27.0 “Electrical Specifications”** for time-out periods.
- **Charge Time Measurement Unit (CTMU)**
- **SR Latch Output:**

1.3 Details on Individual Family Members

Devices in the PIC18(L)F2X/4XK22 family are available in 28-pin and 40/44-pin packages. The block diagram for the device family is shown in Figure 1-1.

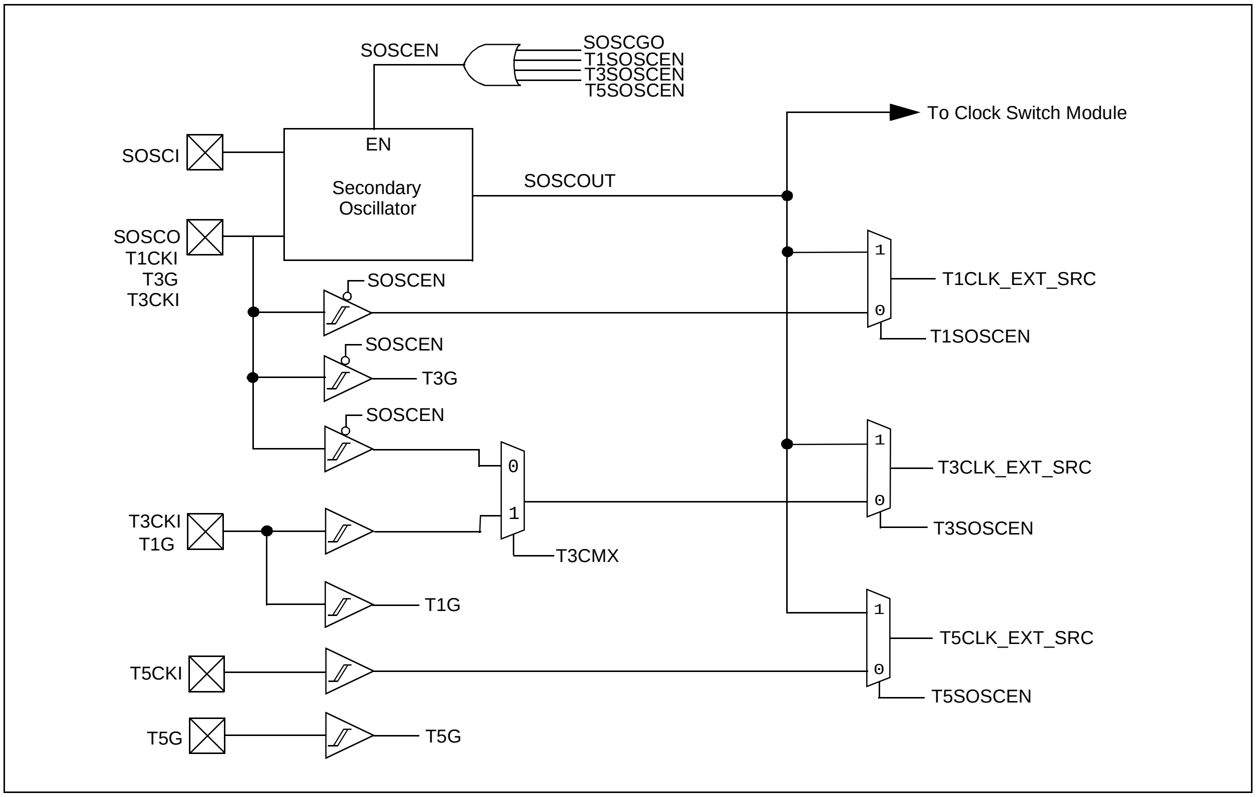
The devices have the following differences:

1. Flash program memory
2. Data Memory SRAM
3. Data Memory EEPROM
4. A/D channels
5. I/O ports
6. ECCP modules (Full/Half Bridge)
7. Input Voltage Range/Power Consumption

All other features for devices in this family are identical. These are summarized in Table 1-1.

The pinouts for all devices are listed in the pin summary tables: Table 2 and Table 3, and I/O description tables: Table 1-2 and Table 1-3.

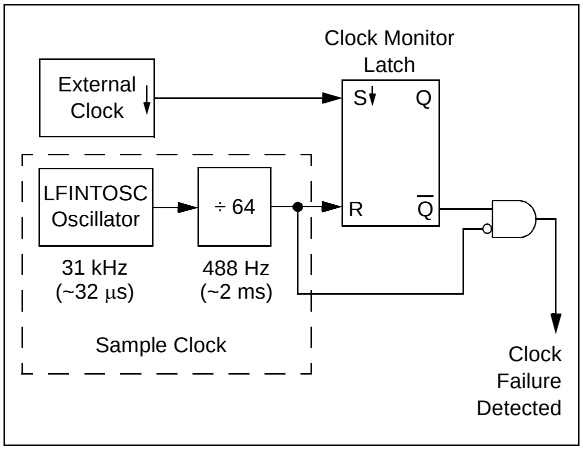
FIGURE 2-4: SECONDARY OSCILLATOR AND EXTERNAL CLOCK INPUTS



2.13 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the device to continue operating should the external oscillator fail. The FSCM can detect oscillator failure any time after the Oscillator Start-up Timer (OST) has expired. The FSCM is enabled by setting the FCMEN bit in the CONFIG1H Configuration register. The FSCM is applicable to all external oscillator modes (LP, XT, HS, EC, RC and RCIO).

FIGURE 2-10: FSCM BLOCK DIAGRAM



2.13.1 FAIL-SAFE DETECTION

The FSCM module detects a failed oscillator by comparing the external oscillator to the FSCM sample clock. The sample clock is generated by dividing the LFINTOSC by 64 (see Figure 2-10). Inside the fail detector block is a latch. The external clock sets the latch on each falling edge of the external clock. The sample clock clears the latch on each rising edge of the sample clock. A failure is detected when an entire half-cycle of the sample clock elapses before the primary clock goes low.

2.13.2 FAIL-SAFE OPERATION

When the external clock fails, the FSCM switches the device clock to an internal clock source and sets the bit flag OSCFIF of the PIR2 register. The OSCFIF flag will generate an interrupt if the OSCFIE bit of the PIE2 register is also set. The device firmware can then take steps to mitigate the problems that may arise from a failed clock. The system clock will continue to be sourced from the internal clock source until the device firmware successfully restarts the external oscillator and switches back to external operation. An automatic transition back to the failed clock source will not occur.

The internal clock source chosen by the FSCM is determined by the IRCF<2:0> bits of the OSCCON register. This allows the internal oscillator to be configured before a failure occurs.

2.13.3 FAIL-SAFE CONDITION CLEARING

The Fail-Safe condition is cleared by either one of the following:

- Any Reset
- By toggling the SCS1 bit of the OSCCON register

Both of these conditions restart the OST. While the OST is running, the device continues to operate from the INTOSC selected in OSCCON. When the OST times out, the Fail-Safe condition is cleared and the device automatically switches over to the external clock source. The Fail-Safe condition need not be cleared before the OSCFIF flag is cleared.

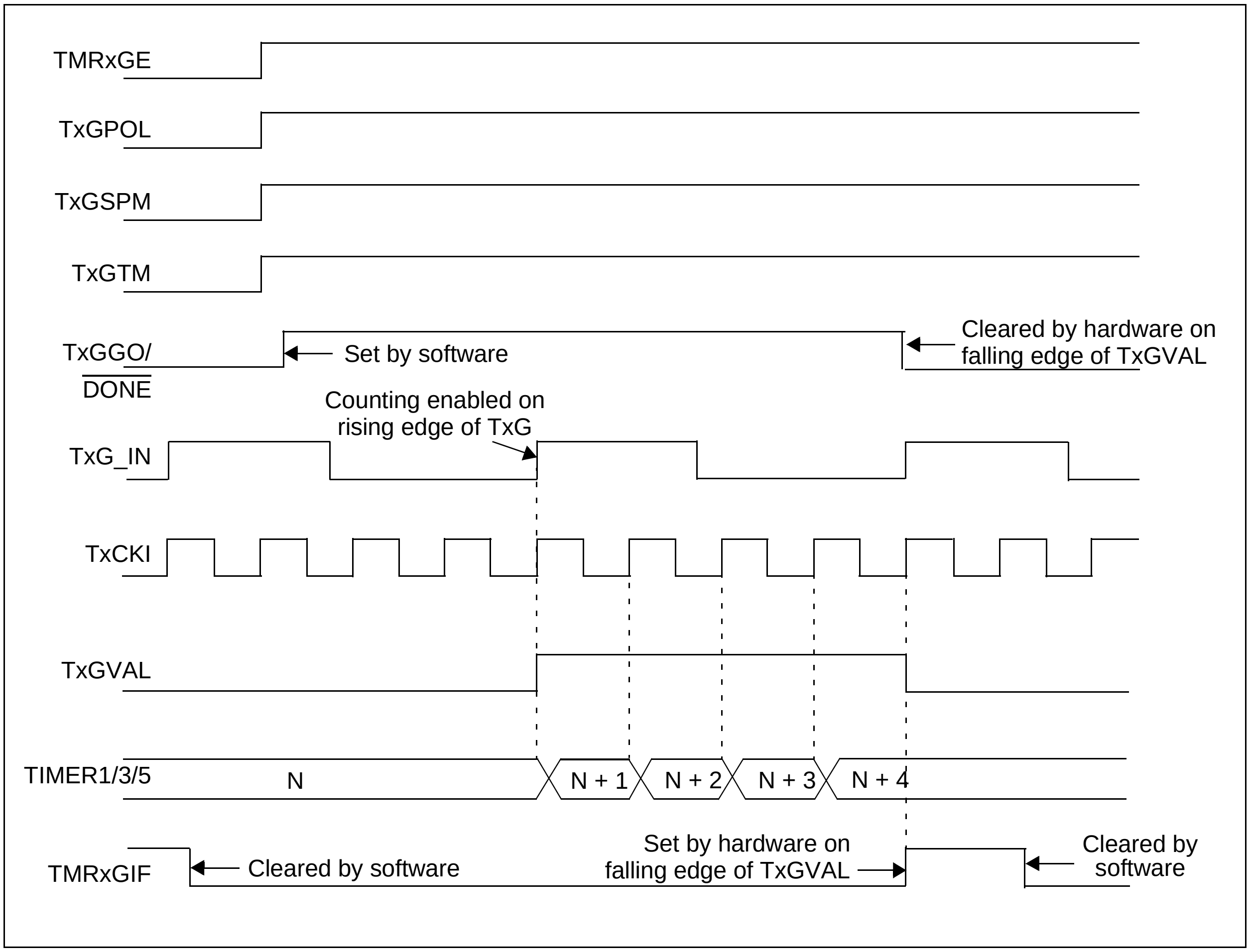
2.13.4 RESET OR WAKE-UP FROM SLEEP

The FSCM is designed to detect an oscillator failure after the Oscillator Start-up Timer (OST) has expired. The OST is used after waking up from Sleep and after any type of Reset. The OST is not used with the EC or RC Clock modes so that the FSCM will be active as soon as the Reset or wake-up has completed.

> **Note:** Due to the wide range of oscillator start-up times, the Fail-Safe circuit is not active during oscillator start-up (i.e., after exiting Reset or Sleep). After an appropriate amount of time, the user should check the OSTS bit of the OSCCON register to verify the oscillator start-up and that the system clock switchover has successfully completed.

> **Note:** When the device is configured for Fail-Safe clock monitoring in either HS, XT, or LS Oscillator modes then the IESO configuration bit should also be set so that the clock will automatically switch from the internal clock to the external oscillator when the OST times out.

FIGURE 12-7: TIMER1/3/5 GATE SINGLE-PULSE AND TOGGLE COMBINED MODE



12.12 Peripheral Module Disable

When a peripheral module is not used or inactive, the module can be disabled by setting the Module Disable bit in the PMD registers. This will reduce power consumption to an absolute minimum. Setting the PMD bits holds the module in Reset and disconnects the module's clock source. The Module Disable bits for Timer1 (TMR1MD), Timer3 (TMR3MD) and Timer5 (TMR5MD) are in the PMD0 Register. See **Section 3.0 "Power-Managed Modes"** for more information.

REGISTER 12-2: TXGCON: TIMER1/3/5 GATE CONTROL REGISTER

R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W/HC-0/u	R-x/x	R/W-0/u	R/W-0/u
TMRxGE	TxGPOL	TxGTM	TxGSPM	TxGGO/$\overline{\text{DONE}}$	TxGVAL	TxGSS<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **TMRxGE:** Timer1/3/5 Gate Enable bit
If TMRxON = 0:
This bit is ignored
If TMRxON = 1:
1 = Timer1/3/5 counting is controlled by the Timer1/3/5 gate function
0 = Timer1/3/5 counts regardless of Timer1/3/5 gate function

bit 6 **TxGPOL:** Timer1/3/5 Gate Polarity bit
1 = Timer1/3/5 gate is active-high (Timer1/3/5 counts when gate is high)
0 = Timer1/3/5 gate is active-low (Timer1/3/5 counts when gate is low)

bit 5 **TxGTM:** Timer1/3/5 Gate Toggle Mode bit
1 = Timer1/3/5 Gate Toggle mode is enabled
0 = Timer1/3/5 Gate Toggle mode is disabled and toggle flip-flop is cleared
Timer1/3/5 gate flip-flop toggles on every rising edge.

bit 4 **TxGSPM:** Timer1/3/5 Gate Single-Pulse Mode bit
1 = Timer1/3/5 gate Single-Pulse mode is enabled and is controlling Timer1/3/5 gate
0 = Timer1/3/5 gate Single-Pulse mode is disabled

bit 3 **TxGGO/$\overline{\textbf{DONE}}$:** Timer1/3/5 Gate Single-Pulse Acquisition Status bit
1 = Timer1/3/5 gate single-pulse acquisition is ready, waiting for an edge
0 = Timer1/3/5 gate single-pulse acquisition has completed or has not been started
This bit is automatically cleared when TxGSPM is cleared.

bit 2 **TxGVAL:** Timer1/3/5 Gate Current State bit
Indicates the current state of the Timer1/3/5 gate that could be provided to TMRxH:TMRxL.
Unaffected by Timer1/3/5 Gate Enable (TMRxGE).

bit 1-0 **TxGSS<1:0>:** Timer1/3/5 Gate Source Select bits
00 = Timer1/3/5 Gate pin
01 = Timer2/4/6 Match PR2/4/6 output (See Table 12-5 for proper timer match selection)
10 = Comparator 1 optionally synchronized output (sync_C1OUT)
11 = Comparator 2 optionally synchronized output (sync_C2OUT)

13.0 TIMER2/4/6 MODULE

There are three identical 8-bit Timer2-type modules available. To maintain pre-existing naming conventions, the Timers are called Timer2, Timer4 and Timer6 (also Timer2/4/6).

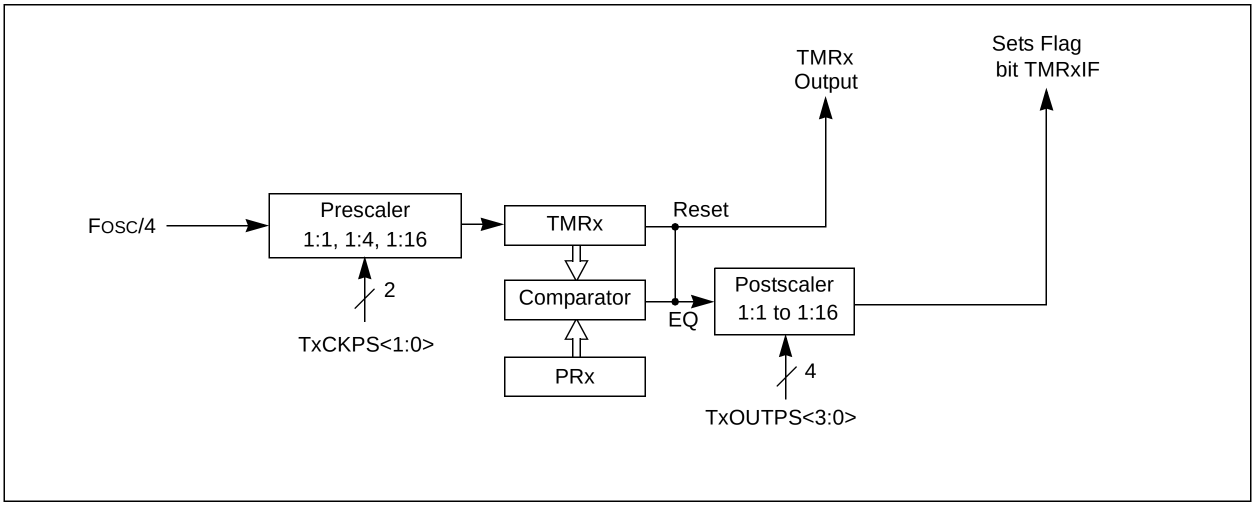
Note:	The ‘x’ variable used in this section is used to designate Timer2, Timer4, or Timer6. For example, TxCON references T2CON, T4CON, or T6CON. PRx references PR2, PR4, or PR6.

The Timer2/4/6 module incorporates the following features:

- 8-bit Timer and Period registers (TMRx and PRx, respectively)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on TMRx match with PRx, respectively
- Optional use as the shift clock for the MSSPx modules (Timer2 only)

See Figure 13-1 for a block diagram of Timer2/4/6.

FIGURE 13-1: TIMER2/4/6 BLOCK DIAGRAM



14.1 Capture Mode

The Capture mode function described in this section is identical for all CCP and ECCP modules available on this device family.

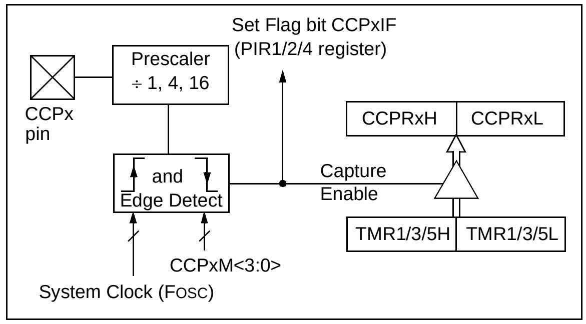
Capture mode makes use of the 16-bit Timer resources, Timer1, Timer3 and Timer5. The timer resources for each CCP capture function are independent and are selected using the CCPTMRS0 and CCPTMRS1 registers. When an event occurs on the CCPx pin, the 16-bit CCPRxH:CCPRxL register pair captures and stores the 16-bit value of the TMRxH:TMRxL register pair, respectively. An event is defined as one of the following and is configured by the CCPxM<3:0> bits of the CCPxCON register:

- Every falling edge
- Every rising edge
- Every 4th rising edge
- Every 16th rising edge

When a capture is made, the corresponding Interrupt Request Flag bit CCPxIF of the PIR1, PIR2 or PIR4 register is set. The interrupt flag must be cleared in software. If another capture occurs before the value in the CCPRxH:CCPRxL register pair is read, the old captured value is overwritten by the new captured value.

Figure 14-1 shows a simplified diagram of the Capture operation.

FIGURE 14-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



14.1.1 CCP PIN CONFIGURATION

In Capture mode, the CCPx pin should be configured as an input by setting the associated TRIS control bit.

Some CCPx outputs are multiplexed on a couple of pins. Table 14-2 shows the CCP output pin multiplexing. Selection of the output pin is determined by the CCPxMX bits in Configuration register 3H (CONFIG3H). Refer to Register 24-4 for more details.

Note:	If the CCPx pin is configured as an output, a write to the port can cause a capture condition.

TABLE 14-2: CCP PIN MULTIPLEXING

CCP OUTPUT	CONFIG 3H Control Bit	Bit Value	PIC18(L)F2XK22 I/O pin	PIC18(L)F4XK22 I/O pin
CCP2	CCP2MX	0	RB3	RB3
		1(*)	RC1	RC1
CCP3	CCP3MX	0(*)	RC6	RE0
		1	RB5	RB5

Legend: * = Default

14.1.2 TIMER1 MODE RESOURCE

The 16-bit Timer resource must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work.

See **Section 12.0 “Timer1/3/5 Module with Gate Control”** for more information on configuring the 16-bit Timers.

14.1.3 SOFTWARE INTERRUPT MODE

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCPxIE interrupt enable bit of the PIE1, PIE2 or PIE4 register clear to avoid false interrupts. Additionally, the user should clear the CCPxIF interrupt flag bit of the PIR1, PIR2 or PIR4 register following any change in Operating mode.

Note:	Clocking the 16-bit Timer resource from the system clock (FOSC) should not be used in Capture mode. In order for Capture mode to recognize the trigger event on the CCPx pin, the Timer resource must be clocked from the instruction clock (FOSC/4) or from an external clock source.

REGISTER 14-2: CCPxCON: ENHANCED CCPx CONTROL REGISTER

R/x-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PxM<1:0>		DCxB<1:0>		CCPxM<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Reset
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **PxM<1:0>**: Enhanced PWM Output Configuration bits

If CCPxM<3:2> = `00, 01, 10`: (Capture/Compare modes)

`xx` = PxA assigned as Capture/Compare input; PxB, PxC, PxD assigned as port pins

Half-Bridge ECCP Modules(1):

If CCPxM<3:2> = `11`: (PWM modes)

`0x` = Single output; PxA modulated; PxB assigned as port pin

`1x` = Half-Bridge output; PxA, PxB modulated with dead-band control

Full-Bridge ECCP Modules(1):

If CCPxM<3:2> = `11`: (PWM modes)

`00` = Single output; PxA modulated; PxB, PxC, PxD assigned as port pins

`01` = Full-Bridge output forward; PxD modulated; PxA active; PxB, PxC inactive

`10` = Half-Bridge output; PxA, PxB modulated with dead-band control; PxC, PxD assigned as port pins

`11` = Full-Bridge output reverse; PxB modulated; PxC active; PxA, PxD inactive

bit 5-4 **DCxB<1:0>:** PWM Duty Cycle Least Significant bits

<u>Capture mode:</u>

Unused

<u>Compare mode:</u>

Unused

<u>PWM mode:</u>

These bits are the two LSbs of the PWM duty cycle. The eight MSbs are found in CCPRxL.

Note 1: See Table 14-1 to determine full-bridge and half-bridge ECCPs for the device being used.

FIGURE 15-9: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

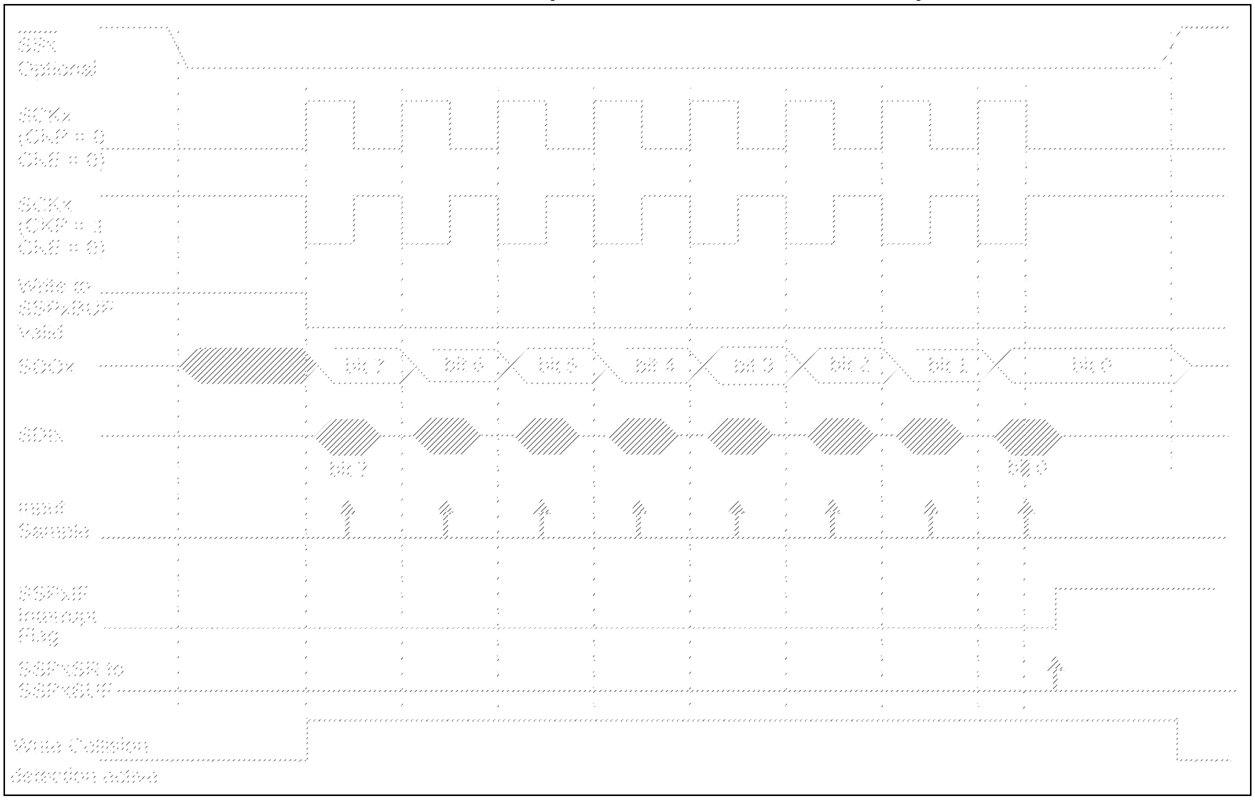


FIGURE 15-10: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)

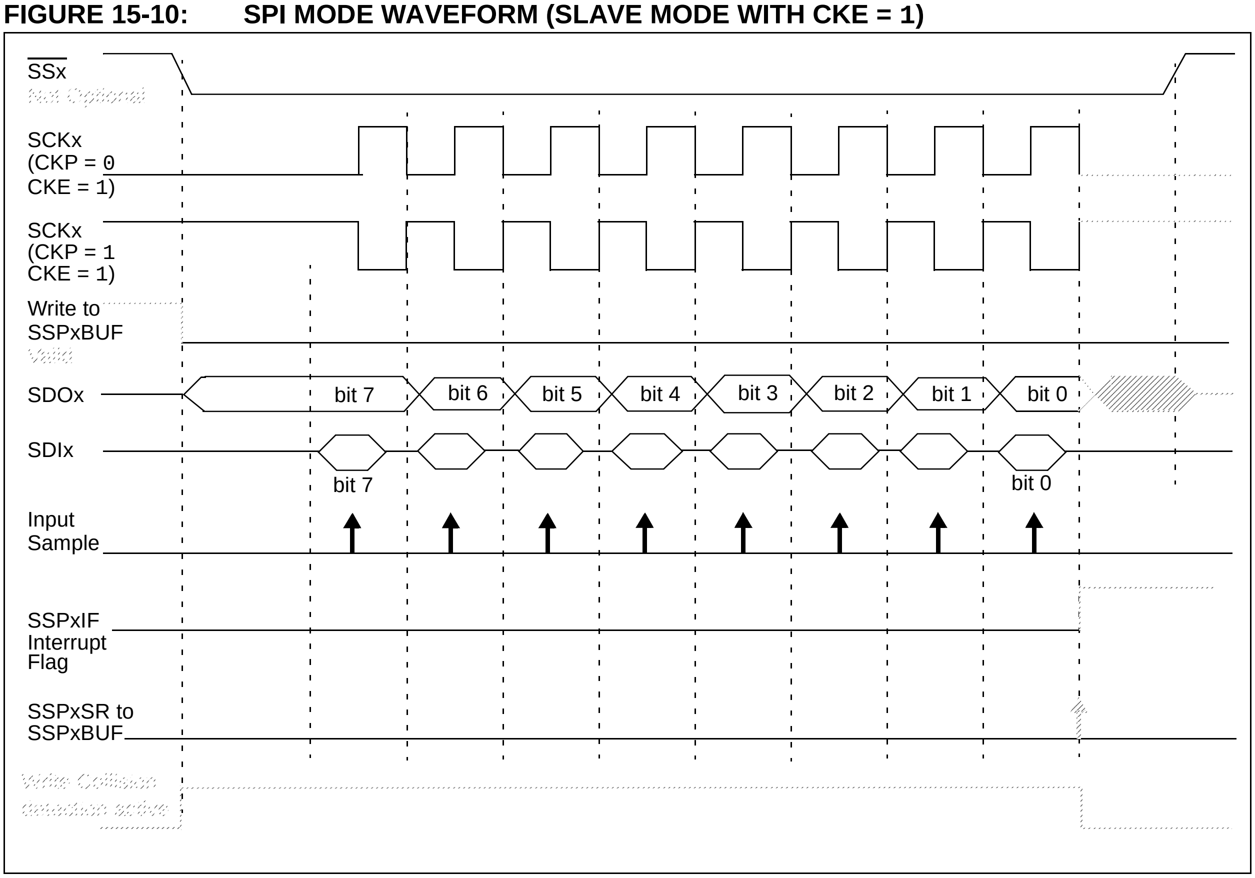
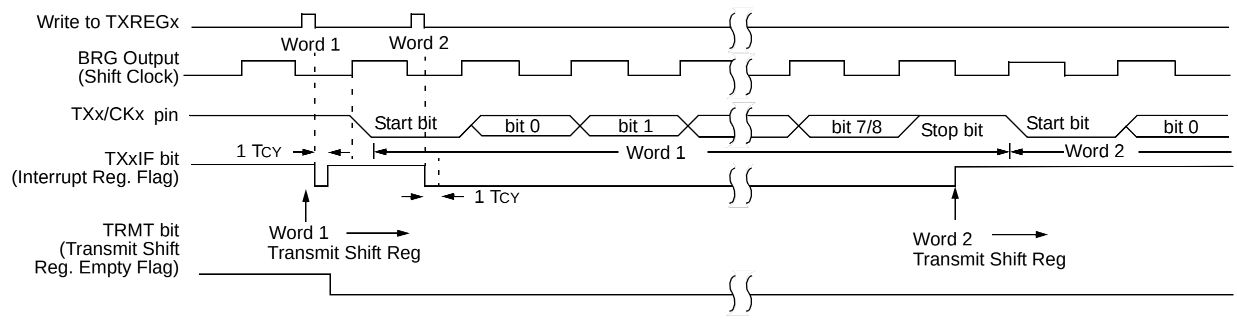


FIGURE 16-4: ASYNCHRONOUS TRANSMISSION (BACK-TO-BACK)



Note: This timing diagram shows two consecutive transmissions.

TABLE 16-1: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
BAUDCON1	ABDOVF	RCIDL	DTRXP	CKTXP	BRG16	—	WUE	ABDEN	271
BAUDCON2	ABDOVF	RCIDL	DTRXP	CKTXP	BRG16	—	WUE	ABDEN	271
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	109
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	121
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	CTMUIP	TMR5GIP	TMR3GIP	TMR1GIP	123
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	117
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	CTMUIE	TMR5GIE	TMR3GIE	TMR1GIE	119
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	112
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	CTMUIF	TMR5GIF	TMR3GIF	TMR1GIF	114
PMD0	UART2MD	UART1MD	TMR6MD	TMR5MD	TMR4MD	TMR3MD	TMR2MD	TMR1MD	52
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	270
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	270
SPBRG1	EUSART1 Baud Rate Generator, Low Byte								—
SPBRGH1	EUSART1 Baud Rate Generator, High Byte								—
SPBRG2	EUSART2 Baud Rate Generator, Low Byte								—
SPBRGH2	EUSART2 Baud Rate Generator, High Byte								—
TXREG1	EUSART1 Transmit Register								—
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	269
TXREG2	EUSART2 Transmit Register								—
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	269

Legend: — = unimplemented locations, read as ‘0’. Shaded bits are not used for asynchronous transmission.

TABLE 16-5: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

BAUD RATE	SYNC = 0, BRGH = 0, BRG16 = 1											
	FOSC = 8.000 MHz			FOSC = 4.000 MHz			FOSC = 3.6864 MHz			FOSC = 1.000 MHz		
	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx :SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)
300	299.9	-0.02	1666	300.1	0.04	832	300.0	0.00	767	300.5	0.16	207
1200	1199	-0.08	416	1202	0.16	207	1200	0.00	191	1202	0.16	51
2400	2404	0.16	207	2404	0.16	103	2400	0.00	95	2404	0.16	25
9600	9615	0.16	51	9615	0.16	25	9600	0.00	23	—	—	—
10417	10417	0.00	47	10417	0.00	23	10473	0.53	21	10417	0.00	5
19.2k	19.23k	0.16	25	19.23k	0.16	12	19.20k	0.00	11	—	—	—
57.6k	55556	-3.55	8	—	—	—	57.60k	0.00	3	—	—	—
115.2k	—	—	—	—	—	—	115.2k	0.00	1	—	—	—

BAUD RATE	SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1											
	FOSC = 64.000 MHz			FOSC = 18.432 MHz			FOSC = 16.000 MHz			FOSC = 11.0592 MHz		
	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx :SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)
300	300	0.00	53332	300.0	0.00	15359	300.0	0.00	13332	300.0	0.00	9215
1200	1200	0.00	13332	1200	0.00	3839	1200.1	0.01	3332	1200	0.00	2303
2400	2400	0.00	6666	2400	0.00	1919	2399.5	-0.02	1666	2400	0.00	1151
9600	9598.1	-0.02	1666	9600	0.00	479	9592	-0.08	416	9600	0.00	287
10417	10417	0.00	1535	10425	0.08	441	10417	0.00	383	10433	0.16	264
19.2k	19.21k	0.04	832	19.20k	0.00	239	19.23k	0.16	207	19.20k	0.00	143
57.6k	57.55k	-0.08	277	57.60k	0.00	79	57.97k	0.64	68	57.60k	0.00	47
115.2k	115.11k	-0.08	138	115.2k	0.00	39	114.29k	-0.79	34	115.2k	0.00	23

BAUD RATE	SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1											
	FOSC = 8.000 MHz			FOSC = 4.000 MHz			FOSC = 3.6864 MHz			FOSC = 1.000 MHz		
	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx :SPBRGx (decimal)	Actual Rate	% Error	SPBRGHx: SPBRGx (decimal)
300	300.0	0.00	6666	300.0	0.01	3332	300.0	0.00	3071	300.1	0.04	832
1200	1200	-0.02	1666	1200	0.04	832	1200	0.00	767	1202	0.16	207
2400	2401	0.04	832	2398	0.08	416	2400	0.00	383	2404	0.16	103
9600	9615	0.16	207	9615	0.16	103	9600	0.00	95	9615	0.16	25
10417	10417	0.00	191	10417	0.00	95	10473	0.53	87	10417	0.00	23
19.2k	19.23k	0.16	103	19.23k	0.16	51	19.20k	0.00	47	19.23k	0.16	12
57.6k	57.14k	-0.79	34	58.82k	2.12	16	57.60k	0.00	15	—	—	—
115.2k	117.6k	2.12	16	111.1k	-3.55	8	115.2k	0.00	7	—	—	—

17.3 Register Definitions: ADC Control

Note:	Analog pin control is determined by the ANSELx registers (see Register 10-2)

REGISTER 17-1: ADCON0: A/D CONTROL REGISTER 0

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	CHS<4:0>					GO/$\overline{\text{DONE}}$	ADON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as ‘0’

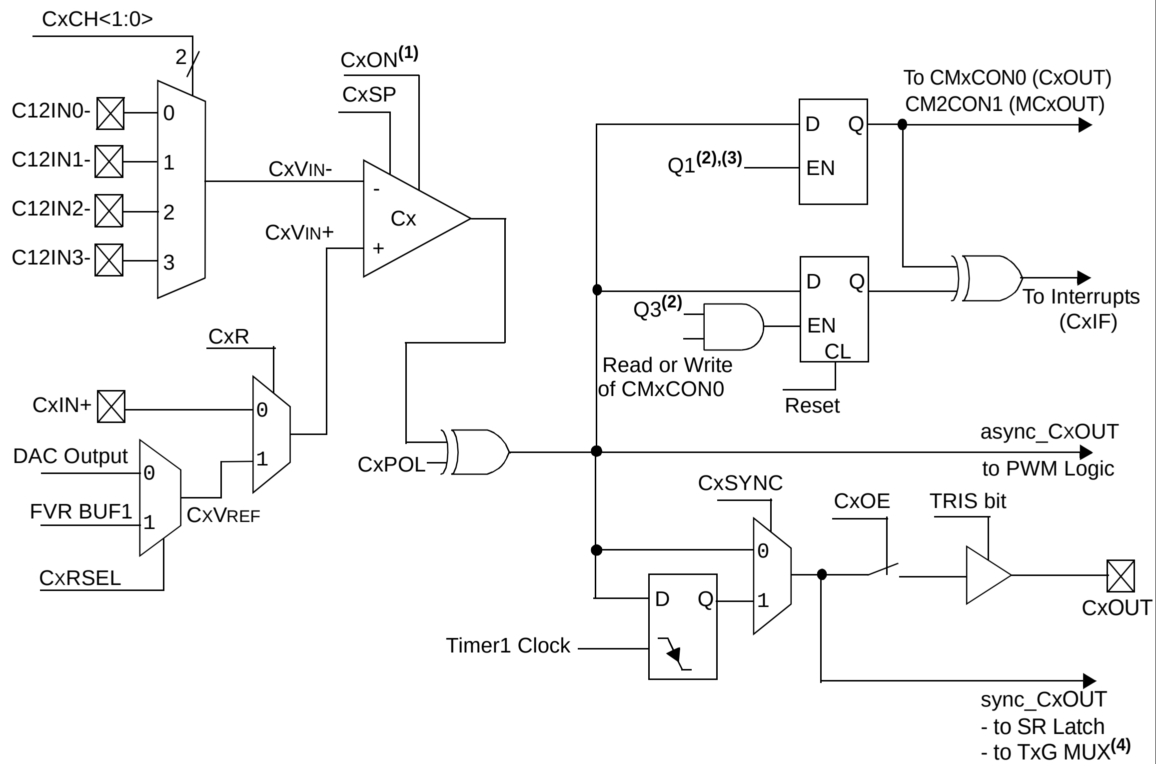
bit 6-2 **CHS<4:0>: Analog Channel Select bits**
00000 = AN0
00001 = AN1
00010 = AN2
00011 = AN3
00100 = AN4
00101 = AN5(1)
00110 = AN6(1)
00111 = AN7(1)
01000 = AN8
01001 = AN9
01010 = AN10
01011 = AN11
01100 = AN12
01101 = AN13
01110 = AN14
01111 = AN15
10000 = AN16
10001 = AN17
10010 = AN18
10011 = AN19
10100 = AN20(1)
10101 = AN21(1)
10110 = AN22(1)
10111 = AN23(1)
11000 = AN24(1)
11001 = AN25(1)
11010 = AN26(1)
11011 = AN27(1)
11100 = Reserved
11101 = CTMU
11110 = DAC
11111 = FVR BUF2 (1.024V/2.048V/2.096V Volt Fixed Voltage Reference)(2)

bit 1 **GO/$\overline{\text{DONE}}$:** A/D Conversion Status bit
1 = A/D conversion cycle in progress. Setting this bit starts an A/D conversion cycle.
This bit is automatically cleared by hardware when the A/D conversion has completed.
0 = A/D conversion completed/not in progress

bit 0 **ADON:** ADC Enable bit
1 = ADC is enabled
0 = ADC is disabled and consumes no operating current

Note 1: Available on PIC18(L)F4XK22 devices only.
2: Allow greater than 15 μs acquisition time when measuring the Fixed Voltage Reference.

FIGURE 18-2: COMPARATOR C1/C2 SIMPLIFIED BLOCK DIAGRAM



Note 1: When C1ON = 0, the C1 comparator will produce a '0' output to the XOR Gate.
2: Q1 and Q3 are phases of the four-phase system clock (FOSC).
3: Q1 is held high during Sleep mode.
4: Synchronized comparator output should not be used to gate Timer1 in conjunction with synchronized T1CKI.

25.2.2 EXTENDED INSTRUCTION SET

ADDFSR **Add Literal to FSR**

Syntax: ADDFSR f, k

Operands: $0 \leq k \leq 63$
$f \in [\ 0, 1, 2\ ]$

Operation: FSR(f) + k → FSR(f)

Status Affected: None

Encoding:

`1110`	`1000`	`ffkk`	`kkkk`

Description: The 6-bit literal 'k' is added to the contents of the FSR specified by 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to FSR

Example: `ADDFSR 2, 23h`

Before Instruction
FSR2 = 03FFh
After Instruction
FSR2 = 0422h

ADDULNK **Add Literal to FSR2 and Return**

Syntax: ADDULNK k

Operands: $0 \leq k \leq 63$

Operation: FSR2 + k → FSR2,
(TOS) → PC

Status Affected: None

Encoding:

`1110`	`1000`	`11kk`	`kkkk`

Description: The 6-bit literal 'k' is added to the contents of FSR2. A `RETURN` is then executed by loading the PC with the TOS.
The instruction takes two cycles to execute; a `NOP` is performed during the second cycle.
This may be thought of as a special case of the `ADDFSR` instruction, where f = 3 (binary '`11`'); it operates only on FSR2.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to FSR
No Operation	No Operation	No Operation	No Operation

Example: `ADDULNK 23h`

Before Instruction
FSR2 = 03FFh
PC = 0100h
After Instruction
FSR2 = 0422h
PC = (TOS)

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction syntax then becomes: {label} instruction argument(s).

27.3 DC Characteristics: RC Run Supply Current, PIC18(L)F2X/4XK22 (Continued)

PIC18LF2X/4XK22		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C					
PIC18F2X/4XK22		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +125°C					
Param No.	**Device Characteristics**	**Typ**	**Max**	**Units**	**Conditions**		
D030		0.35	0.50	mA	-40°C to +125°C	VDD = 1.8V	FOSC = 1 MHz (**RC_RUN** mode, HFINTOSC source)
D031		0.45	0.65	mA	-40°C to +125°C	VDD = 3.0V	
D032		0.40	0.60	mA	-40°C to +125°C	VDD = 2.3V	FOSC = 1 MHz (**RC_RUN** mode, HFINTOSC source)
D033		0.50	0.65	mA	-40°C to +125°C	VDD = 3.0V	
D034		0.55	0.75	mA	-40°C to +125°C	VDD = 5.0V	
D035		1.3	2.0	mA	-40°C to +125°C	VDD = 1.8V	FOSC = 16 MHz (**RC_RUN** mode, HFINTOSC source)
D036		2.2	3.0	mA	-40°C to +125°C	VDD = 3.0V	
D037		1.7	2.0	mA	-40°C to +125°C	VDD = 2.3V	FOSC = 16 MHz (**RC_RUN** mode, HFINTOSC source)
D038		2.2	3.0	mA	-40°C to +125°C	VDD = 3.0V	
D039		2.5	3.5	mA	-40°C to +125°C	VDD = 5.0V	
D041		6.2	8.5	mA	-40°C to +125°C	VDD = 3.0V	FOSC = 64 MHz (**RC_RUN** mode, HFINTOSC + PLL source)
D043		6.2	8.5	mA	-40°C to +125°C	VDD = 3.0V	FOSC = 64 MHz (**RC_RUN** mode, HFINTOSC + PLL source)
D044		6.8	9.5	mA	-40°C to +125°C	VDD = 5.0V	

Note 1: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
Test condition: All Peripheral Module Control bits in PMD0, PMD1 and PMD2 set to ‘1’.

2: The test conditions for all IDD measurements in active operation mode are:
All I/O pins set as outputs driven to Vss;
$\overline{\text{MCLR}}$ = VDD;
OSC1 = external square wave, from rail-to-rail (PRI_RUN and PRI_IDLE only).

27.7 DC Characteristics: Secondary Oscillator Supply Current, PIC18(L)F2X/4XK22

PIC18LF2X/4XK22		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C					
PIC18F2X/4XK22		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +125°C					
Param No.	**Device Characteristics**	**Typ**	**Max**	**Units**	**Conditions**		
D135		0.9	18	μA	-40°C	VDD = 1.8V	Fosc = 32 kHz (**SEC_IDLE** mode, SOSC source)
		1.0	18	μA	+25°C		
		1.1	—	μA	+60°C		
		1.3	20	μA	+85°C		
		2.3	22	μA	+125°C		
D136		1.3	20	μA	-40°C	VDD = 3.0V	
		1.4	20	μA	+25°C		
		1.5	—	μA	+60°C		
		1.8	22	μA	+85°C		
		2.9	25	μA	+125°C		
D137		12	30	μA	-40°C	VDD = 2.3V	Fosc = 32 kHz (**SEC_IDLE** mode, SOSC source)
		13	30	μA	+25°C		
		14	30	μA	+85°C		
		16	45	μA	+125°C		
D138		13	35	μA	-40°C	VDD = 3.0V	
		14	35	μA	+25°C		
		16	35	μA	+85°C		
		18	50	μA	+125°C		
D139		14	40	μA	-40°C	VDD = 5.0V	
		15	40	μA	+25°C		
		16	40	μA	+85°C		
		18	60	μA	+125°C		

Note 1: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
Test condition: All Peripheral Module Control bits in PMD0, PMD1 and PMD2 set to '1'.

2: The test conditions for all IDD measurements in active operation mode are:
All I/O pins set as outputs driven to Vss;
$\overline{\text{MCLR}}$ = VDD;
SOSCI / SOSCO = complementary external square wave, from rail-to-rail.

TABLE 27-3: FIXED VOLTAGE REFERENCE (FVR) SPECIFICATIONS

Operating Conditions: -40°C < TA < +125°C (unless otherwise stated)							
Param No.	**Sym**	**Characteristics**	**Min**	**Typ**	**Max**	**Units**	**Comments**
VR01	VROUT	VR voltage output to ADC	0.973	1.024	1.085	V	1x output, VDD ≥ 2.5V
			1.946	2.048	2.171	V	2x output, VDD ≥ 2.5V
			3.891	4.096	4.342	V	4x output, VDD ≥ 4.75V (PIC18F2X/4XK22)
VR02	VROUT	VR voltage output all other modules	0.942	1.024	1.096	V	1x output, VDD ≥ 2.5V
			1.884	2.048	2.191	V	2x output, VDD ≥ 2.5V
			3.768	4.096	4.383	V	4x output, VDD ≥ 4.75V (PIC18F2X/4XK22)
VR04*	TSTABLE	Settling Time	—	25	100	μs	0 to 125°C

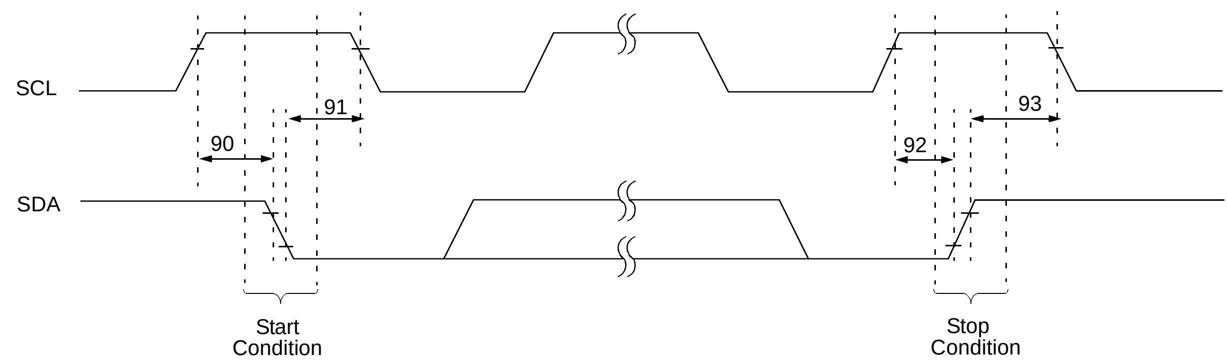
* These parameters are characterized but not tested.

TABLE 27-4: CHARGE TIME MEASUREMENT UNIT (CTMU) SPECIFICATIONS

Operating Conditions: 1.8V < VDD < 5.5V, -40°C < TA < +125°C (unless otherwise stated)							
Param No.	**Sym**	**Characteristics**	**Min**	**Typ(1)**	**Max**	**Units**	**Comments**
CT01	IOUT1	CTMU Current Source, Base Range	—	0.55	—	μA	IRNG<1:0>=01
CT02	IOUT2	CTMU Current Source, 10X Range	—	5.5	—	μA	IRNG<1:0>=10
CT03	IOUT3	CTMU Current Source, 100X Range	—	55	—	μA	IRNG<1:0>=11 VDD ≥ 3.0V

Note 1: Nominal value at center point of current trim range (CTMUICON<7:2>=000000).

FIGURE 27-19: MASTER SSP I²C BUS START/STOP BITS TIMING WAVEFORMS



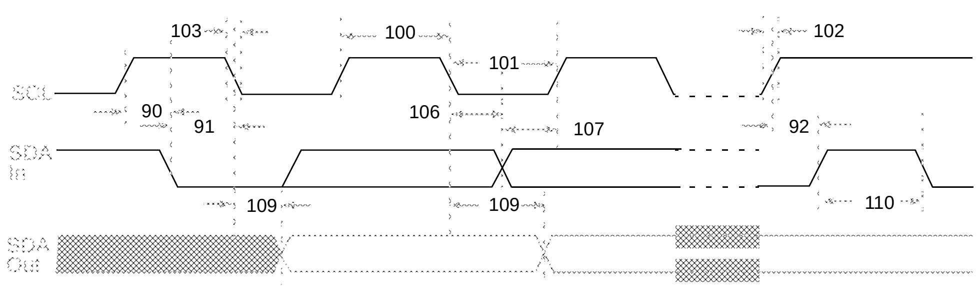
Note: Refer to Figure 27-6 for load conditions.

TABLE 27-17: MASTER SSP I²C BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	Start Condition Setup Time	100 kHz mode	2(Tosc)(BRG + 1)	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	2(Tosc)(BRG + 1)	—		
			1 MHz mode(1)	2(Tosc)(BRG + 1)	—		
91	THD:STA	Start Condition Hold Time	100 kHz mode	2(Tosc)(BRG + 1)	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	2(Tosc)(BRG + 1)	—		
			1 MHz mode(1)	2(Tosc)(BRG + 1)	—		
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	2(Tosc)(BRG + 1)	—	ns	
			400 kHz mode	2(Tosc)(BRG + 1)	—		
			1 MHz mode(1)	2(Tosc)(BRG + 1)	—		
93	THD:STO	Stop Condition Hold Time	100 kHz mode	2(Tosc)(BRG + 1)	—	ns	
			400 kHz mode	2(Tosc)(BRG + 1)	—		
			1 MHz mode(1)	2(Tosc)(BRG + 1)	—		

Note 1: Maximum pin capacitance = 10 pF for all I²C pins.

FIGURE 27-20: MASTER SSP I²C BUS DATA TIMING



Note: Refer to Figure 27-6 for load conditions.

FIGURE 28-26: PIC18LF2X/4XK22 TYPICAL IDD: RC_RUN HF-INTOSC

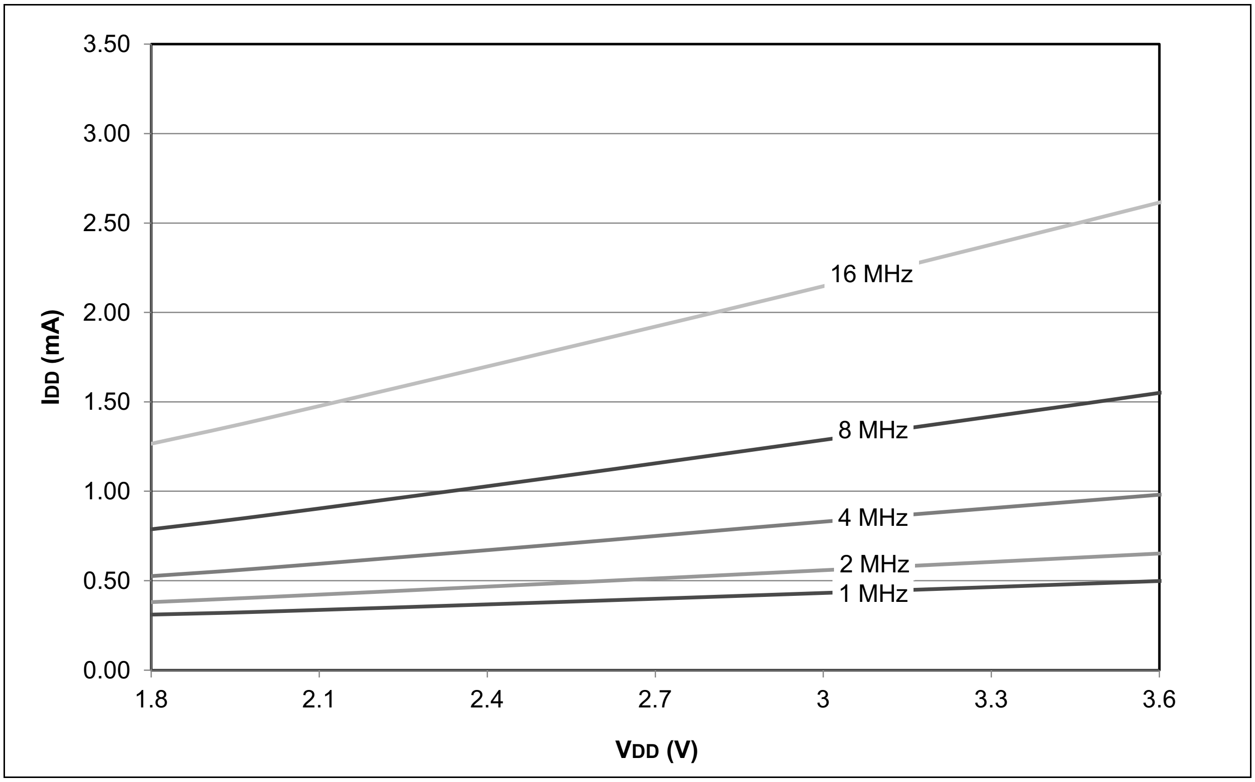


FIGURE 28-27: PIC18LF2X/4XK22 MAXIMUM IDD: RC_RUN HF-INTOSC

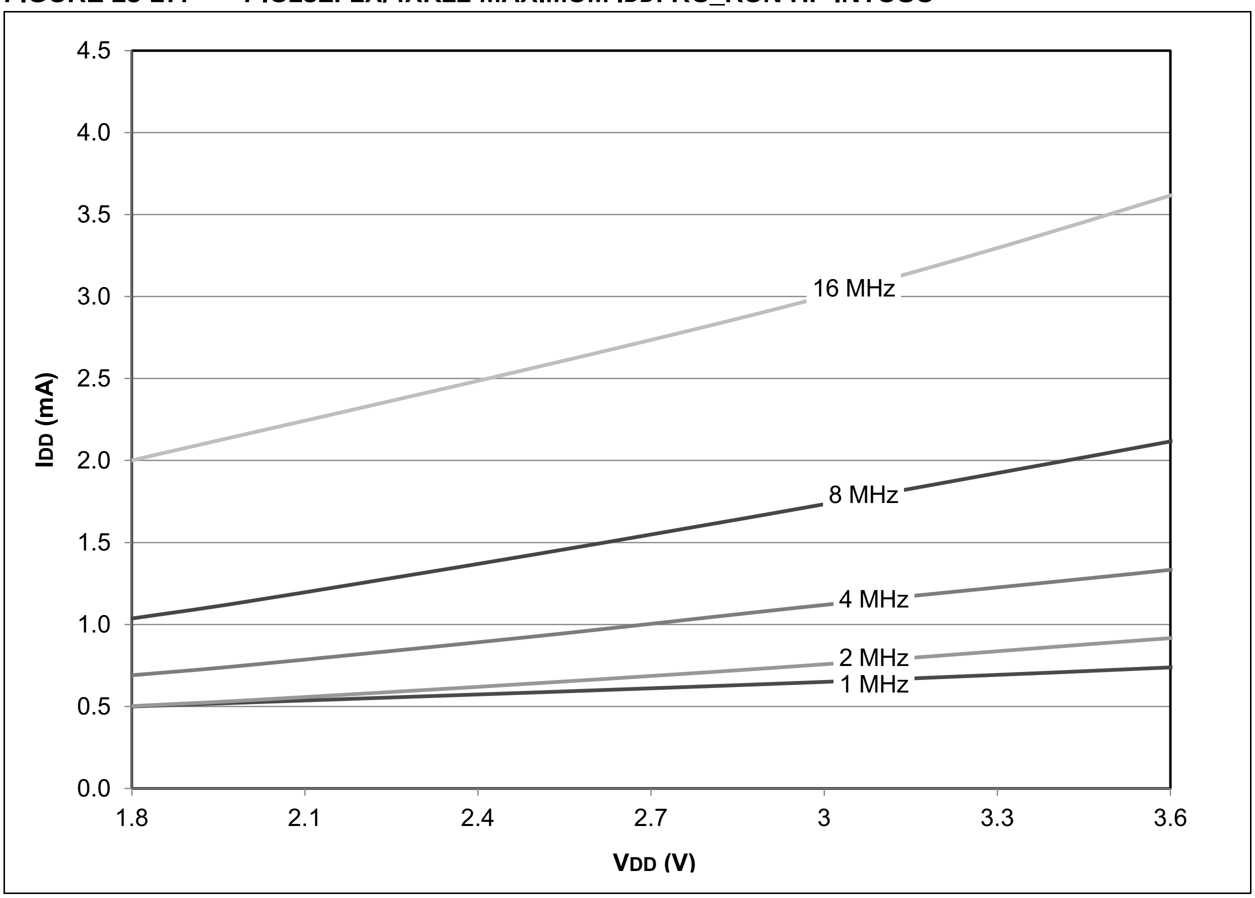


FIGURE 28-84: PIC18(L)F2X/4XK22 PIN INPUT LEAKAGE